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Understanding Embedded - FPGAs (Field Programmable Gate Array)

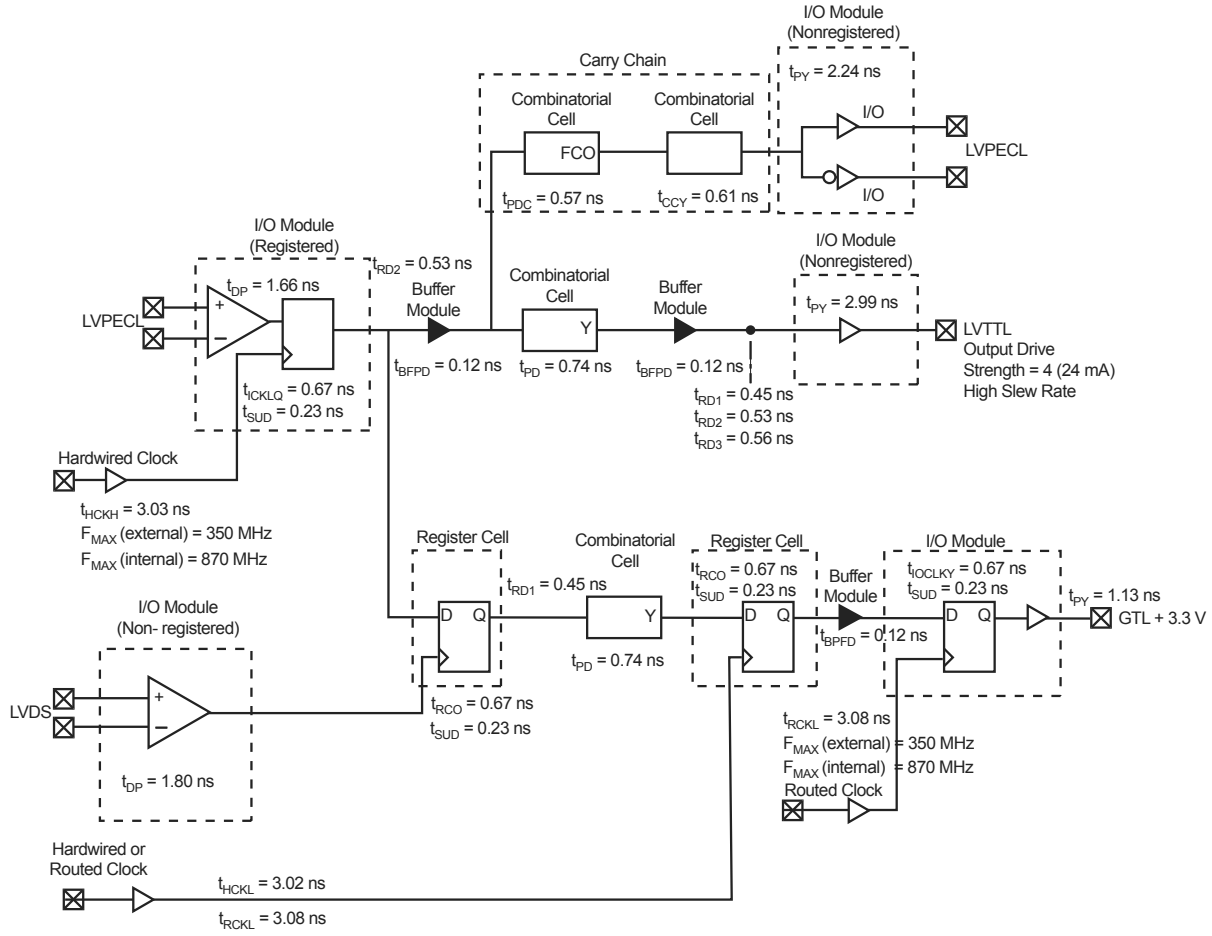
Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Discontinued at Digi-Key
Number of LABs/CLBs	32256
Number of Logic Elements/Cells	-
Total RAM Bits	294912
Number of I/O	684
Number of Gates	2000000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 85°C (TA)
Package / Case	1152-BGA
Supplier Device Package	1152-FPBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/microsemi/ax2000-2fg1152i

Timing Model



Note: Worst case timing data for the AX1000, –2 speed grade

Figure 2-1 • **Worst Case Timing Data**

Hardwired Clock – Using LVTTL 24 mA High Slew Clock I/O

External Setup

$= (t_{DP} + t_{RD2} + t_{SUD}) – t_{HCKL}$

$= (1.72 + 0.53 + 0.23) – 3.02 = –0.54$ ns

Clock-to-Out (Pad-to-Pad)

$= t_{HCKL} + t_{RCO} + t_{RD1} + t_{PY}$

$= 3.02 + 0.67 + 0.45 + 2.99 = 7.13$ ns

Routed Clock – Using LVTTL 24 mA High Slew Clock I/O

External Setup

$= (t_{DP} + t_{RD2} + t_{SUD}) – t_{RCKH}$

$= (1.72 + 0.53 + 0.23) – 3.13 = –0.65$ ns

Clock-to-Out (Pad-to-Pad)

$= t_{RCKH} + t_{RCO} + t_{RD1} + t_{PY}$

$= 3.13 + 0.67 + 0.45 + 3.03 = 7.24$ ns

User I/Os[2]

Introduction

The Axcelerator family features a flexible I/O structure, supporting a range of mixed voltages (1.5 V, 1.8 V, 2.5 V, and 3.3 V) with its bank-selectable I/Os. Table 2-8 on page 2-12 contains the I/O standards supported by the Axcelerator family, and Table 2-10 on page 2-12 compares the features of the different I/O standards.

Each I/O provides programmable slew rates, drive strengths, and weak pull-up and weak pull-down circuits. The slew rate setting is effective for both rising and falling edges.

I/O standards, except 3.3 V PCI and 3.3 V PCI-X, are capable of hot insertion. 3.3 V PCI and 3.3 V PCI-X are 5 V tolerant with the aid of an external resistor.

The input buffer has an optional user-configurable delay element. The element can reduce or eliminate the hold time requirement for input signals registered within the I/O cell. The value for the delay is set on a bank-wide basis. Note that the delay WILL be a function of process variations as well as temperature and voltage changes.

Each I/O includes three registers: an input (InReg), an output (OutReg), and an enable register (EnReg). I/Os are organized into banks, and there are eight banks per device—two per side (Figure 2-6 on page 2-18). Each I/O bank has a common VCCI, the supply voltage for its I/Os.

For voltage-referenced I/Os, each bank also has a common reference-voltage bus, VREF. While VREF must have a common voltage for an entire I/O bank, its location is user-selectable. In other words, any user I/O in the bank can be selected to be a VREF.

The location of the VREF pin should be selected according to the following rules:

- Any pin that is assigned as a VREF can control a maximum of eight user I/O pad locations in each direction (16 total maximum) within the same I/O bank.
- I/O pad locations listed as no connects are counted as part of the 16 maximum. In many cases, this leads to fewer than eight user I/O package pins in each direction being controlled by a VREF pin.
- Dedicated I/O pins such as GND and VCCI are counted as part of the 16.
- The two user I/O pads immediately adjacent on each side of the VREF pin (four in total) may only be used as inputs. The exception is when there is a VCCI/GND pair separating the VREF pin and the user I/O pad location.
- The user does not need to assign VREF pins for OUTBUF and TRIBUF. VREF pins are needed only for input and bidirectional I/Os.

The differential amplifier supply voltage VCCDA should be connected to 3.3 V.

A user can gain access to the various I/O standards in three ways:

- Instantiate specific library macros that represent the desired specific standard.
- Use generic I/O macros and then use Designer's PinEditor to specify the desired I/O standards (please note that this is not applicable to differential standards).
- A combination of the first two methods.

Refer to the *I/O Features in Axcelerator Family Devices* application note and the *Antifuse Macro Library Guide* for more details.

2. *Do not use an external resister to pull the I/O above V_{CCI} for a higher logic "1" voltage level. The desired higher logic "1" voltage level will be degraded due to a small I/O current, which exists when the I/O is pulled up above V_{CCI}.*

Using the Differential I/O Standards

Differential I/O macros should be instantiated in the netlist. The settings for these I/O standards cannot be changed inside Designer. Note that there are no tristated or bidirectional I/O buffers for differential standards.

Using the Voltage-Referenced I/O Standards

Using these I/O standards is similar to that of single-ended I/O standards. Their settings can be changed in Designer.

Using DDR (Double Data Rate)

In Double Data Rate mode, new data is present on every transition of the clock signal. Clock and data lines have identical bandwidth and signal integrity requirements, making it very efficient for implementing very high-speed systems.

To implement a DDR, users need to:

1. Instantiate an input buffer (with the required I/O standard)
2. Instantiate the DDR_REG macro (Figure 2-6)
3. Connect the output from the Input buffer to the input of the DDR macro

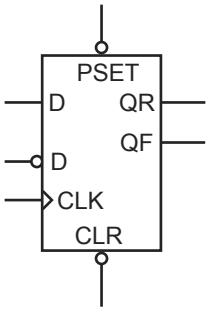


Figure 2-6 • **DDR Register**

Macros for Specific I/O Standards

There are different macro types for any I/O standard or feature that determine the required VCCI and VREF voltages for an I/O. The generic buffer macros require the LVTTL standard with slow slew rate and 24 mA-drive strength. LVTTL can support high slew rate but this should only be used for critical signals.

Most of the macro symbols represent variations of the six generic symbol types:

- CLKBUF: Clock Buffer
- HCLKBUF: Hardwired Clock Buffer
- INBUF: Input Buffer
- OUTBUF: Output Buffer
- TRIBUF: Tristate Buffer
- BIBUF: Bidirectional Buffer

Other macros include the following:

- Differential I/O standard macros: The LVDS and LVPECL macros either have a pair of differential inputs (e.g. INBUF_LVDS) or a pair of differential outputs (e.g. OUTBUF_LVPECL).
- Pull-up and pull-down variations of the INBUF, BIBUF, and TRIBUF macros. These are available only with TTL and LVCMOS thresholds. They can be used to model the behavior of the pull-up and pull-down resistors available in the architecture. Whenever an input pin is left unconnected, the output pin will either go high or low rather than unknown. This allows users to leave inputs unconnected without having the negative effect on simulation of propagating unknowns.
- DDR_REG macro. It can be connected to any I/O standard input buffers (i.e. INBUF) to implement a double data rate register. Designer software will map it to the I/O module in the same way it maps the other registers to the I/O module.

1.8 V LVCMOS

Low-Voltage Complementary Metal-Oxide Semiconductor for 1.8 V is an extension of the LVCMOS standard (JESD8-5) used for general-purpose 1.8 V applications. It uses a 3.3 V tolerant CMOS input buffer and a push-pull output buffer.

***Table 2-26* • DC Input and Output Levels**

VIL		VIH		VOL	VOH	IOL	IOH
Min., V	**Max., V**	**Min., V**	**Max., V**	**Max., V**	**Min., V**	**mA**	**mA**
–0.3	0.2 VCCI	0.7 VCCI	3.6	0.2	VCCI – 0.2	8 mA	–8 mA

AC Loadings

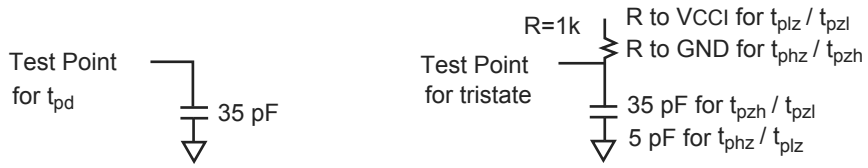


***Figure 2-17* • AC Test Loads**

***Table 2-27* • AC Waveforms, Measuring Points, and Capacitive Loads**

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ) (V)	C_{load} (pF)
0	1.8	0.5 VCCI	N/A	35

*Note: * Measuring Point = VTRIP*

Timing Characteristics

***Table 2-35* • 3.3 V PCI I/O Module**
Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_J = 70°C

		–2 Speed		–1 Speed		Std Speed		
Parameter	**Description**	**Min.**	**Max.**	**Min.**	**Max.**	**Min.**	**Max.**	**Units**
3.3 V PCI Output Module Timing								
t_{DP}	Input Buffer		1.57		1.79		2.10	ns
t_{PY}	Output Buffer		1.91		2.18		2.56	ns
t_{ENZL}	Enable to Pad Delay through the Output Buffer—Z to Low		1.61		1.62		1.63	ns
t_{ENZH}	Enable to Pad Delay through the Output Buffer—Z to High		1.45		1.47		1.47	ns
t_{ENLZ}	Enable to Pad Delay through the Output Buffer—Low to Z		2.55		2.90		3.41	ns
t_{ENHZ}	Enable to Pad Delay through the Output Buffer—High to Z		3.52		4.01		4.72	ns
t_{IOCLKQ}	Sequential Clock-to-Q for the I/O Input Register		0.67		0.77		0.90	ns
t_{IOCLKY}	Clock-to-output Y for the I/O Output Register and the I/O Enable Register		0.67		0.77		0.90	ns
t_{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t_{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t_{HD}	Data Input Hold		0.00		0.00		0.00	ns
t_{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t_{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.39		ns
t_{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t_{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t_{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t_{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t_{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	
t_{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns

Voltage-Referenced I/O Standards

GTL+

Gunning Transceiver Logic Plus is a high-speed bus standard (JESD8-3). It requires a differential amplifier input buffer and an Open Drain output buffer. The VCCI pin should be connected to 2.5 V or 3.3 V. Note that 2.5 V GTL+ is not supported across the full military temperature range.

***Table 2-37* • DC Input and Output Levels**

VIL		VIH		VOL	VOH	IOL	IOH
Min., V	**Max., V**	**Min., V**	**Max., V**	**Max., V**	**Min., V**	**mA**	**mA**
N/A	VREF – 0.1	VREF + 0.1	N/A	0.6	NA	NA	NA

AC Loadings

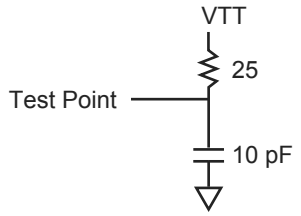


***Figure 2-19* • AC Test Loads**

***Table 2-38* • AC Waveforms, Measuring Points, and Capacitive Loads**

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ) (V)	C_{load} (pF)
VREF – 0.2	VREF + 0.2	VREF	1.0	10

*Note: * Measuring Point = VTRIP*

Timing Characteristics

***Table 2-39* • 2.5 V GTL+ I/O Module**
Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 2.3 V, T_J = 70°C

		–2 Speed		–1 Speed		Std Speed		
Parameter	**Description**	**Min.**	**Max.**	**Min.**	**Max.**	**Min.**	**Max.**	**Units**
2.5 V GTL+ I/O Module Timing								
t_{DP}	Input Buffer		1.71		1.95		2.29	ns
t_{PY}	Output Buffer		1.13		1.29		1.52	ns
t_{ICLKQ}	Clock-to-Q for the I/O input register		0.67		0.77		0.90	ns
t_{OCLKQ}	Clock-to-Q for the I/O output register and the I/O enable register		0.67		0.77		0.90	ns
t_{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t_{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t_{HD}	Data Input Hold		0.00		0.00		0.00	ns
t_{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t_{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.39		ns
t_{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t_{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t_{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t_{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t_{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	ns
t_{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns

SSTL3

Stub Series Terminated Logic for 3.3 V is a general-purpose 3.3 V memory bus standard (JESD8-8). The Axcelerator devices support both classes of this standard. This requires a differential amplifier input buffer and a push-pull output buffer.

Class I

***Table 2-50* • DC Input and Output Levels**

VIL		VIH		VOL	VOH	IOL	IOH
Min., V	**Max., V**	**Min., V**	**Max., V**	**Max., V**	**Min., V**	**mA**	**mA**
-0.3	VREF – 0.2	VREF +0.2	3.6	VREF – 0.6	VREF + 0.6	8	–8

AC Loadings

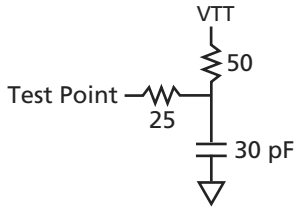


***Figure 2-23* • AC Test Loads**

***Table 2-51* • AC Waveforms, Measuring Points, and Capacitive Loads**

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ) (V)	C_{load} (pF)
VREF – 1.0	VREF + 1.0	VREF	1.50	30

*Note: *Measuring Point = VTRIP*

Timing Characteristics

***Table 2-52* • 3.3 V SSTL3 Class I I/O Module**
Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_J = 70°C

		–2 Speed		–1 Speed		Std Speed		
Parameter	**Description**	**Min.**	**Max.**	**Min.**	**Max.**	**Min.**	**Max.**	**Units**
3.3 V SSTL3 Class I I/O Module Timing								
t_{DP}	Input Buffer		1.78		2.03		2.39	ns
t_{PY}	Output Buffer		2.17		2.47		2.91	ns
t_{ICLKQ}	Clock-to-Q for the I/O input register		0.67		0.77		0.90	ns
t_{OCLKQ}	Clock-to-Q for the I/O output register and the I/O enable register		0.67		0.77		0.90	ns
t_{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t_{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t_{HD}	Data Input Hold		0.00		0.00		0.00	ns
t_{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t_{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.39		ns
t_{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t_{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t_{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t_{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t_{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	ns
t_{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns

Vertical and Horizontal Routing

Vertical and Horizontal Tracks provide both local and long distance routing (Figure 2-37 on page 2-62). These tracks are composed of both short-distance, segmented routing and across-chip routing tracks (segmented at core tile boundaries). The short-distance, segmented routing resources can be concatenated through antifuse connections to build longer routing tracks.

These short-distance routing tracks can be used within and between SuperClusters or between modules of non-adjacent SuperClusters. They can be connected to the Output Tracks and to any logic module input (R-cell, C-cell, Buffer, and TX module).

The across-chip horizontal and vertical routing provides long-distance routing resources. These resources interface with the rest of the routing structures through the RX and TX modules (Figure 2-37). The RX module is used to drive signals from the across-chip horizontal and vertical routing to the Output Tracks within the SuperCluster. The TX module is used to drive vertical and horizontal across-chip routing from either short-distance horizontal tracks or from Output Tracks. The TX module can also be used to drive signals from vertical across-chip tracks to horizontal across-chip tracks and vice versa.

Figure 2-36 • **FastConnect Routing**

Figure 2-37 • **Horizontal and Vertical Tracks**

The ClockTileDist Cluster contains an HCLKMux (HM) module for each of the four HCLK trees and a CLKMux (CM) module for each of the CLK trees. The HCLK branches then propagate horizontally through the middle of the core tile to HCLKColDist (HD) modules in every SuperCluster column. The CLK branches propagate vertically through the center of the core tile to CLKRowDist (RD) modules in every SuperCluster row. Together, the HCLK and CLK branches provide for a low-skew global fanout within the core tile (Figure 2-40 and Figure 2-41).

Figure 2-40 • **CTD, CD, and HD Module Layout**

Figure 2-41 • **HCLK and CLK Distribution within a Core Tile**

Timing Characteristics

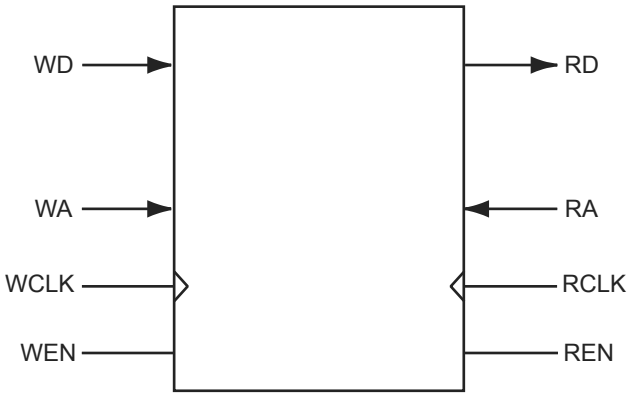


Figure 2-58 • **SRAM Model**

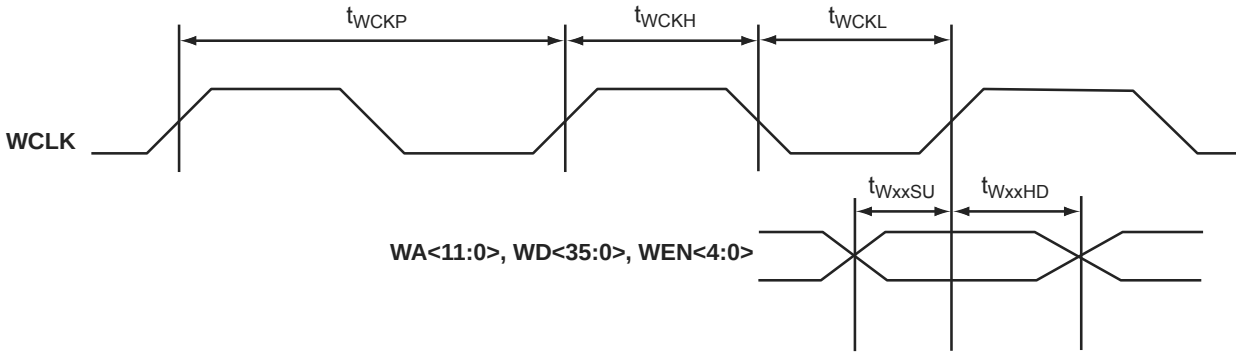


Figure 2-59 • **RAM Write Timing Waveforms**

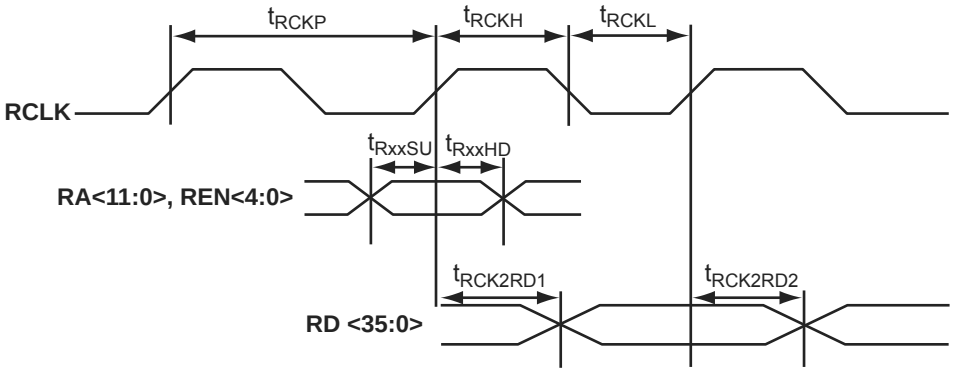


Figure 2-60 • **RAM Read Timing Waveforms**

FG256	
AX250 Function	Pin Number
Bank 0	
IO01NB0F0	B4
IO01PB0F0	B3
IO03NB0F0	A4
IO03PB0F0	A3
IO05NB0F0	B6
IO05PB0F0	B5
IO07NB0F0	A6
IO07PB0F0	A5
IO12NB0F0/HCLKAN	B8
IO12PB0F0/HCLKAP	B7
IO13NB0F0/HCLKBN	A9
IO13PB0F0/HCLKBP	A8
Bank 1	
IO14NB1F1/HCLKCN	C10
IO14PB1F1/HCLKCP	C9
IO15NB1F1/HCLKDN	B11
IO15PB1F1/HCLKDP	B10
IO17NB1F1	A13
IO17PB1F1	A12
IO19NB1F1	B13
IO19PB1F1	B12
IO21NB1F1	C12
IO21PB1F1	C11
IO23NB1F1	A15
IO23PB1F1	B14
IO26NB1F1	C15
IO26PB1F1	C14
IO27NB1F1	D13
IO27PB1F1	D12
Bank 2	
IO29NB2F2	F13
IO29PB2F2	E13
IO30NB2F2	F14
IO30PB2F2	E14

FG256	
AX250 Function	Pin Number
IO32NB2F2	C16
IO32PB2F2	B16
IO33NB2F2	F15
IO33PB2F2	E15
IO35NB2F2	H13
IO35PB2F2	G13
IO36NB2F2	E16
IO36PB2F2	D16
IO38NB2F2	H15
IO38PB2F2	G15
IO39NB2F2	H14
IO39PB2F2	G14
IO40NB2F2	G16
IO40PB2F2	F16
IO43NB2F2	K15
IO43PB2F2	K16
IO44NB2F2	J16
IO44PB2F2	H16
Bank 3	
IO45NB3F3	K13
IO45PB3F3	J13
IO46NB3F3	K14
IO46PB3F3	J14
IO52NB3F3	L15
IO52PB3F3	L16
IO54NB3F3	P16
IO54PB3F3	N16
IO55PB3F3	M16
IO56NB3F3	P15
IO56PB3F3	R16
IO58NB3F3	N15
IO58PB3F3	M15
IO59NB3F3	M13
IO59PB3F3	L13
IO61NB3F3	M14

FG256	
AX250 Function	Pin Number
IO61PB3F3	L14
Bank 4	
IO62NB4F4	N12
IO62PB4F4	N13
IO63NB4F4	T14
IO63PB4F4	R14
IO66PB4F4	T15
IO67NB4F4	R12
IO67PB4F4	R13
IO69NB4F4	P11
IO69PB4F4	P12
IO70PB4F4	T11
IO73NB4F4	T12
IO73PB4F4	T13
IO74NB4F4/CLKEN	R9
IO74PB4F4/CLKEP	R10
IO75NB4F4/CLKFN	T8
IO75PB4F4/CLKFP	T9
Bank 5	
IO76NB5F5/CLKGN	P7
IO76PB5F5/CLKGP	P8
IO77NB5F5/CLKHN	R6
IO77PB5F5/CLKHP	R7
IO79NB5F5	T5
IO79PB5F5	T6
IO81NB5F5	P5
IO81PB5F5	P6
IO83NB5F5	T3
IO83PB5F5	T4
IO85NB5F5	R3
IO85PB5F5	R4
IO88NB5F5	R1
IO88PB5F5	T2
IO89NB5F5	N4
IO89PB5F5	N5

FG676	
AX500 Function	Pin Number
IO102PB4F9	AB15
IO103NB4F9/CLKEN	AE16
IO103PB4F9/CLKEP	AF16
IO104NB4F9/CLKFN	AE14
IO104PB4F9/CLKFP	AE15
Bank 5	
IO105NB5F10/CLKGN	AE12
IO105PB5F10/CLKGP	AE13
IO106NB5F10/CLKHN	AE11
IO106PB5F10/CLKHP	AF11
IO107NB5F10	Y12
IO107PB5F10	AA13
IO108NB5F10	AC12
IO108PB5F10	AB12
IO109NB5F10	AC10
IO109PB5F10	AC11
IO110NB5F10	AF9
IO110PB5F10	AF10
IO111NB5F10	Y11
IO111PB5F10	AA12
IO112NB5F10	AE9
IO112PB5F10	AE10
IO113NB5F10	AC9
IO113PB5F10	AD9
IO114NB5F11	AF6
IO114PB5F11	AF7
IO115NB5F11	AA10
IO115PB5F11	AB10
IO116NB5F11	AE7
IO116PB5F11	AE8
IO117NB5F11	AD7
IO117PB5F11	AD8
IO118NB5F11	AC7
IO118PB5F11	AC8
IO119NB5F11	AD6

FG676	
AX500 Function	Pin Number
IO119PB5F11	AE6
IO120NB5F11	AE5
IO120PB5F11	AF5
IO121NB5F11	AF4
IO121PB5F11	AE4
IO122NB5F11	AC5
IO122PB5F11	AC6
IO123NB5F11	AD4
IO123PB5F11	AD5
IO124NB5F11	AB6
IO124PB5F11	AB7
IO125NB5F11	AE3
IO125PB5F11	AF3
Bank 6	
IO126NB6F12	AB3
IO126PB6F12	AC3
IO127NB6F12	AA2
IO127PB6F12	AB2
IO128NB6F12	AC2
IO128PB6F12	AD2
IO129NB6F12	Y1
IO129PB6F12	AA1
IO130NB6F12	Y3
IO130PB6F12	AA3
IO131NB6F12	U6
IO131PB6F12	V6
IO132NB6F12	W2
IO132PB6F12	Y2
IO133NB6F12	V4
IO133PB6F12	W4
IO134NB6F12	V3
IO134PB6F12	W3
IO135NB6F12	V1
IO135PB6F12	V2
IO136NB6F13	U4

FG676	
AX500 Function	Pin Number
IO136PB6F13	U5
IO137NB6F13	T6
IO137PB6F13	T7
IO138NB6F13	T5
IO138PB6F13	T4
IO139NB6F13	R6
IO139PB6F13	R7
IO140NB6F13	T3
IO140PB6F13	U3
IO141NB6F13	U1
IO141PB6F13	U2
IO142NB6F13	R2
IO142PB6F13	T2
IO143NB6F13	P3
IO143PB6F13	R3
IO144NB6F13	P5
IO144PB6F13	P4
IO145NB6F13	P6
IO145PB6F13	P7
IO146NB6F13	R1
IO146PB6F13	T1
Bank 7	
IO147NB7F14	N6
IO147PB7F14	N7
IO148NB7F14	N5
IO148PB7F14	N4
IO149NB7F14	N2
IO149PB7F14	N3
IO150NB7F14	L1
IO150PB7F14	M1
IO151NB7F14	M2
IO151PB7F14	M3
IO152NB7F14	M5
IO152PB7F14	M4
IO153NB7F14	M7

FG676	
AX1000 Function	**Pin Number**
IO197PB6F18	Y6
IO198NB6F18	AD1
IO198PB6F18	AE1
IO199NB6F18	AA2
IO199PB6F18	AB2
IO200NB6F18	Y3
IO200PB6F18	AA3
IO201NB6F18	V5
IO201PB6F18	W5
IO202NB6F18	AB1
IO202PB6F18	AC1
IO203NB6F19	V4
IO203PB6F19	W4
IO204NB6F19	V3
IO204PB6F19	W3
IO205NB6F19	U6
IO205PB6F19	V6
IO206NB6F19	W2
IO206PB6F19	Y2
IO207NB6F19	U4
IO207PB6F19	U5
IO208NB6F19	Y1
IO208PB6F19	AA1
IO209NB6F19	T6
IO209PB6F19	T7
IO211NB6F19	T3
IO211PB6F19	U3
IO212NB6F19	V1
IO212PB6F19	V2
IO213NB6F19	T5
IO213PB6F19	T4
IO214NB6F20	U1
IO214PB6F20	U2
IO215NB6F20	R6
IO215PB6F20	R7
IO217NB6F20	R5

FG676	
AX1000 Function	**Pin Number**
IO217PB6F20	R4
IO218NB6F20	R2
IO218PB6F20	T2
IO219NB6F20	P3
IO219PB6F20	R3
IO220NB6F20	R1
IO220PB6F20	T1
IO221NB6F20	P6
IO221PB6F20	P7
IO223NB6F20	P5
IO223PB6F20	P4
Bank 7	
IO225NB7F21	N5
IO225PB7F21	N4
IO226NB7F21	N2
IO226PB7F21	N3
IO227NB7F21	N6
IO227PB7F21	N7
IO229NB7F21	M7
IO229PB7F21	M6
IO231NB7F21	M5
IO231PB7F21	M4
IO232NB7F21	L1
IO232PB7F21	M1
IO233NB7F21	M2
IO233PB7F21	M3
IO235NB7F21	K2
IO235PB7F21	L2
IO236NB7F22	L5
IO236PB7F22	L4
IO237NB7F22	L6
IO237PB7F22	L7
IO238NB7F22	K3
IO238PB7F22	L3
IO240NB7F22	J1
IO240PB7F22	K1

FG676	
AX1000 Function	**Pin Number**
IO241NB7F22	K6
IO241PB7F22	K5
IO242NB7F22	H2
IO242PB7F22	J2
IO243NB7F22	J4
IO243PB7F22	K4
IO244NB7F22	H3
IO244PB7F22	J3
IO245NB7F22	G2
IO245PB7F22	G1
IO247NB7F23	J6
IO247PB7F23	J5
IO248NB7F23	E1
IO248PB7F23	F1
IO249NB7F23	E2
IO249PB7F23	F2
IO250NB7F23	G4
IO250PB7F23	H4
IO251NB7F23	F3
IO251PB7F23	G3
IO253NB7F23	H6
IO253PB7F23	H5
IO254NB7F23	D2
IO254PB7F23	D1
IO255NB7F23	E4
IO255PB7F23	F4
IO256NB7F23	D3
IO256PB7F23	E3
IO257NB7F23	F5
IO257PB7F23	G5
Dedicated I/O	
GND	A1
GND	A13
GND	A14
GND	A19
GND	A26

FG896	
AX2000 Function	Pin Number
IO124NB2F11	P29
IO124PB2F11	P30
IO125NB2F11	R22
IO125PB2F11	R23
IO127NB2F11	R24
IO127PB2F11	R25
IO128NB2F11	R29
IO128PB2F11	R30
Bank 3	
IO129NB3F12	T27
IO129PB3F12	R27
IO130NB3F12	T29
IO130PB3F12	T30
IO131NB3F12	T22
IO131PB3F12	T23
IO132NB3F12	U26
IO132PB3F12	T26
IO133NB3F12	U24
IO133PB3F12	T24
IO135NB3F12	U23
IO135PB3F12	U22
IO136NB3F12	U29
IO136PB3F12	U30
IO137NB3F12	V28
IO137PB3F12	U28
IO138NB3F12	V27
IO138PB3F12	U27
IO139NB3F13	V25
IO139PB3F13	U25
IO141NB3F13	V23
IO141PB3F13	V22
IO142NB3F13	W29
IO142PB3F13	V29
IO143NB3F13	W26
IO143PB3F13	V26

FG896	
AX2000 Function	Pin Number
IO145NB3F13	W24
IO145PB3F13	V24
IO146NB3F13	W27
IO146PB3F13	W28
IO147NB3F13	Y28
IO147PB3F13	Y27
IO148NB3F13	Y30
IO148PB3F13	W30
IO149NB3F13	Y25
IO149PB3F13	W25
IO150NB3F14	AA29
IO150PB3F14	Y29
IO151NB3F14	AC29
IO152NB3F14	AA26
IO152PB3F14	Y26
IO153NB3F14	Y23
IO153PB3F14	W23
IO154NB3F14	AB30
IO154PB3F14	AA30
IO155NB3F14	AB27
IO155PB3F14	AA27
IO156NB3F14	AC28
IO156PB3F14	AB28
IO157NB3F14	AA24
IO157PB3F14	Y24
IO158NB3F14	AF29
IO158PB3F14	AF30
IO159NB3F14	AB25
IO159PB3F14	AA25
IO160NB3F14	AE30
IO160PB3F14	AD30
IO161NB3F15	AE29
IO161PB3F15	AD29
IO162NB3F15	AD27
IO162PB3F15	AC27

FG896	
AX2000 Function	Pin Number
IO163NB3F15	AC26
IO163PB3F15	AB26
IO164NB3F15	AE28
IO164PB3F15	AD28
IO165NB3F15	AC24
IO165PB3F15	AB24
IO166NB3F15	AG28
IO166PB3F15	AF28
IO167NB3F15	AE26
IO167PB3F15	AD26
IO168NB3F15	AD25
IO168PB3F15	AC25
IO169NB3F15	AF27
IO169PB3F15	AE27
IO170NB3F15	AB23
IO170PB3F15	AA23
Bank 4	
IO171NB4F16	AG29
IO171PB4F16	AG30
IO172NB4F16	AF24
IO172PB4F16	AF25
IO173NB4F16	AG25
IO173PB4F16	AG26
IO174NB4F16	AJ25
IO174PB4F16	AJ26
IO175NB4F16	AK26
IO175PB4F16	AK27
IO176NB4F16	AE23
IO176PB4F16	AE24
IO177NB4F16	AH24
IO177PB4F16	AH25
IO178NB4F16	AD23
IO178PB4F16	AC23
IO179PB4F16	AJ27
IO180NB4F16	AG23

FG896	
AX2000 Function	Pin Number
IO245PB5F23	AG8
IO246NB5F23	AD8
IO246PB5F23	AD9
IO247NB5F23	AG7
IO247PB5F23	AH7
IO248NB5F23	AK5
IO249NB5F23	AJ5
IO249PB5F23	AJ6
IO250NB5F23	AC8
IO250PB5F23	AC9
IO251NB5F23	AH6
IO251PB5F23	AG6
IO252NB5F23	AF6
IO252PB5F23	AF7
IO253NB5F23	AG2
IO253PB5F23	AG1
IO254NB5F23	AE7
IO254PB5F23	AE8
IO255NB5F23	AG5
IO255PB5F23	AH5
IO256NB5F23	AJ4
IO256PB5F23	AK4
Bank 6	
IO257NB6F24	AE4
IO257PB6F24	AF4
IO258NB6F24	AB7
IO258PB6F24	AC7
IO259NB6F24	AD5
IO259PB6F24	AE5
IO260NB6F24	AF1
IO260PB6F24	AF2
IO261NB6F24	AF3
IO261PB6F24	AG3
IO262NB6F24	AC4
IO262PB6F24	AD4

FG896	
AX2000 Function	Pin Number
IO263NB6F24	AD3
IO263PB6F24	AE3
IO264NB6F24	AB6
IO264PB6F24	AC6
IO265NB6F24	AD1
IO265PB6F24	AE1
IO266NB6F24	AA8
IO266PB6F24	AB8
IO267NB6F25	AB5
IO267PB6F25	AC5
IO268NB6F25	AB3
IO268PB6F25	AC3
IO269NB6F25	AC2
IO269PB6F25	AD2
IO270NB6F25	Y7
IO270PB6F25	AA7
IO271NB6F25	AA4
IO271PB6F25	AB4
IO272NB6F25	Y6
IO272PB6F25	AA6
IO273NB6F25	AB1*
IO273PB6F25	AE2*
IO274NB6F25	W8
IO274PB6F25	Y8
IO275NB6F25	Y5
IO275PB6F25	AA5
IO277NB6F25	AA2
IO277PB6F25	AA1
IO278NB6F26	W6
IO278PB6F26	W7
IO279NB6F26	Y3
IO279PB6F26	Y4
IO280NB6F26	V8
IO280PB6F26	V9
IO281NB6F26	Y1

FG896	
AX2000 Function	Pin Number
IO281PB6F26	Y2
IO282NB6F26	V5
IO282PB6F26	W5
IO284NB6F26	V7
IO284PB6F26	V6
IO285NB6F26	W3
IO285PB6F26	W4
IO286NB6F26	U8
IO286PB6F26	U9
IO287NB6F26	W1
IO287PB6F26	W2
IO288NB6F26	U7
IO288PB6F26	U6
IO290NB6F27	U4
IO290PB6F27	V4
IO291NB6F27	U3
IO291PB6F27	V3
IO292NB6F27	T5
IO292PB6F27	U5
IO293NB6F27	U2
IO293PB6F27	V2
IO294NB6F27	T8
IO294PB6F27	T9
IO296NB6F27	T1
IO296PB6F27	U1
IO298NB6F27	T7
IO298PB6F27	T6
IO299NB6F27	R2
IO299PB6F27	T2
Bank 7	
IO300NB7F28	R8
IO300PB7F28	R9
IO302NB7F28	R4
IO302PB7F28	R5
IO303NB7F28	P1

FG1152	
AX2000 Function	Pin Number
GND	N1
GND	N13
GND	N22
GND	N34
GND	P14
GND	P15
GND	P16
GND	P17
GND	P18
GND	P19
GND	P20
GND	P21
GND	R14
GND	R15
GND	R16
GND	R17
GND	R18
GND	R19
GND	R20
GND	R21
GND	R3
GND	R32
GND	T14
GND	T15
GND	T16
GND	T17
GND	T18
GND	T19
GND	T20
GND	T21
GND	U14
GND	U15
GND	U16
GND	U17
GND	U18

FG1152	
AX2000 Function	Pin Number
GND	U19
GND	U20
GND	U21
GND	U30
GND	U5
GND	V14
GND	V15
GND	V16
GND	V17
GND	V18
GND	V19
GND	V20
GND	V21
GND	V30
GND	V5
GND	W14
GND	W15
GND	W16
GND	W17
GND	W18
GND	W19
GND	W20
GND	W21
GND	Y14
GND	Y15
GND	Y16
GND	Y17
GND	Y18
GND	Y19
GND	Y20
GND	Y21
GND	Y3
GND	Y32
GND/LP	G6
NC	A17

FG1152	
AX2000 Function	Pin Number
NC	A26
NC	AB2
NC	AB33
NC	AC34
NC	AD3
NC	AD34
NC	AE31
NC	AE33
NC	AE34
NC	AF1
NC	AF34
NC	AG2
NC	AG4
NC	AH1
NC	AH2
NC	AH31
NC	AH32
NC	AH34
NC	AJ1
NC	AJ2
NC	AJ3
NC	AJ31
NC	AJ32
NC	AJ33
NC	AJ34
NC	AJ4
NC	AL29
NC	AM19
NC	AM7
NC	AN13
NC	AN17
NC	AN25
NC	AN27
NC	AN8
NC	AP17

CG624	
AX1000 Function	Pin Number
Bank 0	
IO00NB0F0	F8
IO00PB0F0	F7
IO02NB0F0	G7
IO02PB0F0	G6
IO04NB0F0	E9
IO04PB0F0	D8
IO06NB0F0	G9
IO06PB0F0	G8
IO07PB0F0	B6
IO08NB0F0	F10
IO08PB0F0	F9
IO09PB0F0	C7
IO10NB0F0	H8
IO10PB0F0	H7
IO11NB0F0	D10
IO11PB0F0	D9
IO12NB0F1	B5
IO12PB0F1	B4
IO13NB0F1	A7
IO13PB0F1	A6
IO14NB0F1	C9
IO14PB0F1	C8
IO15PB0F1	B7
IO16NB0F1	A5
IO16PB0F1	A4
IO17NB0F1	A9
IO17PB0F1	B9
IO18NB0F1	D12
IO18PB0F1	D11
IO20NB0F1	B11
IO20PB0F1	B10
IO21NB0F1	A11
IO21PB0F1	A10
IO22NB0F2	H10
IO22PB0F2	H9

CG624	
AX1000 Function	Pin Number
IO23NB0F2	E11
IO23PB0F2	F11
IO24NB0F2	D7
IO24PB0F2	E7
IO25PB0F2	B12
IO26NB0F2	H11
IO26PB0F2	G11
IO27NB0F2	C11
IO27PB0F2	B8
IO28NB0F2	J13
IO28PB0F2	K13
IO29NB0F2	J8
IO29PB0F2	J7
IO30NB0F2/HCLKAN	G13
IO30PB0F2/HCLKAP	G12
IO31NB0F2/HCLKBN	C13
IO31PB0F2/HCLKBP	C12
Bank 1	
IO32NB1F3/HCLKCN	G15
IO32PB1F3/HCLKCP	G14
IO33NB1F3/HCLKDN	B14
IO33PB1F3/HCLKDP	B13
IO34NB1F3	G16
IO34PB1F3	H16
IO35NB1F3	C17
IO35PB1F3	B18
IO36NB1F3	H18
IO36PB1F3	H15
IO37NB1F3	H13
IO38NB1F3	E15
IO38PB1F3	F15
IO39NB1F3	D14
IO39PB1F3	C14
IO40NB1F3	D16
IO40PB1F3	D15
IO41NB1F4	F16

CG624	
AX1000 Function	Pin Number
IO42NB1F4	G21
IO42PB1F4	G20
IO43NB1F4	A16
IO43PB1F4	A15
IO44NB1F4	A20
IO44PB1F4	A19
IO45NB1F4	B17
IO45PB1F4	B16
IO46NB1F4	G17
IO46PB1F4	H17
IO47NB1F4	A17
IO48NB1F4	C19
IO48PB1F4	C18
IO49NB1F4	B20
IO49PB1F4	B19
IO50NB1F4	H20
IO50PB1F4	H19
IO51NB1F4	A22
IO51PB1F4	A21
IO52NB1F4	C21
IO52PB1F4	C20
IO53NB1F4	B22
IO53PB1F4	B21
IO54NB1F5	J18
IO54PB1F5	J19
IO55NB1F5	D18
IO55PB1F5	D17
IO56NB1F5	F20
IO56PB1F5	F19
IO58NB1F5	E17
IO58PB1F5	F17
IO60NB1F5	D20
IO60PB1F5	D19
IO62NB1F5	E18
IO62PB1F5	F18
IO63NB1F5	G19

4 – Datasheet Information

List of Changes

The following table lists critical changes that were made in the current version of the document.

Revision	Changes	Page
Revision 18 (March 2012)	Table 2-1 • Absolute Maximum Ratings was updated to correct the maximum DC core supply voltage (VCCA) from 1.6 V to 1.7 V (SAR 36786). The maximum input voltage (VI) was corrected from 3.75 V to 4.1 V (SAR 35419).	2-1
	Values for tristate leakage current IOZ, and IIH and IIL were added to Table 2-3 • Standby Current (SARs 35774, 32021).	2-2
	Figure 2-2 • VCCPLX and VCOMPLX Power Supply Connect was updated to correct the units for the resistance from "W" to Ω (SAR 36415).	2-9
	In the Introduction to the "User I/Os" section, the following sentence was added to clarify the slew rate setting (SAR 34943): The slew rate setting is effective for both rising and falling edges.	2-11
	Figure 2-3 • Use of an External Resistor for 5 V Tolerance was revised to show the VCCI and GND clamp diodes. The explanatory text above the figure was revised as well (SAR 34942).	2-13
	EQ 3 for 5 V tolerance was corrected to change Vdiode from 0.6 V to 0.7 V (SAR 36786).	2-13
	Additional information was added to the "Using the Weak Pull-Up and Pull-Down Circuits" section to clarify how the weak pull-up and pull-down resistors are physically implemented (SAR 34945).	2-17
	The description for the C_{INCLK} parameter in Table 2-18 • Input Capacitance was changed from "Input capacitance on clock pin" to "Input capacitance on HCLK and RCLK pin" (SAR 34944).	2-21
	Table 2-19 • I/O Input Rise Time and Fall Time* is new (SAR 34942).	2-21
	The minimum VIL for 1.5 V LVCMOS and PCI was corrected from –0.5 to –0.3 in Table 2-29 • DC Input and Output Levels and Table 2-33 • DC Input and Output Levels (SAR 34358).	2-38, 2-40
	Support for simulating the GCLR/ GPSET feature in the Axcelerator Family was added in Libero software v9.0 SPI1. Reference to the section explaining this in the *Antifuse Macro Library Guide* was added to the "R-Cell" section (SAR 26413).	2-58
	The enable signal in Figure 2-32 • R-Cell Delays was corrected to show it is active low rather than active high (SAR 34946).	2-59
Revision 17 (September 2011)	The versioning system for datasheets has been changed. Datasheets are assigned a revision number that increments each time the datasheet is revised. The "Axcelerator Family Device Status" table indicates the status for each device in the device family.	iii
	The "Features" section, "Programmable Interconnect Element" section, and "Security" section were revised to clarify that although no existing security measures can give an absolute guarantee, Microsemi FPGAs implement the best security available in the industry (SAR 32865).	i, 1-1, 2-108

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